74HC237

3-to-8 line decoder, demultiplexer with address latches

Rev. 03 — 12 November 2004

Product data sheet

1. General description

The 74HC237 is a high-speed Si-gate CMOS device and is pin compatible with low power Schottky TTL (LSTTL). The 74HC237 is specified in compliance with JEDEC standard no. 7A.

The 74HC237 is a 3-to-8 line decoder, demultiplexer with latches at the three address inputs (An). The 74HC237 essentially combines the 3-to-8 decoder function with a 3-bit storage latch. When the latch is enabled ($\overline{\text{LE}}$ = LOW), the 74HC237 acts as a 3-to-8 active LOW decoder. When the latch enable ($\overline{\text{LE}}$) goes from LOW-to-HIGH, the last data present at the inputs before this transition, is stored in the latches. Further address changes are ignored as long as $\overline{\text{LE}}$ remains HIGH.

The output enable input ($\overline{E}1$ and E2) controls the state of the outputs independent of the address inputs or latch operation. All outputs are HIGH unless $\overline{E}1$ is LOW and E2 is HIGH.

The 74HC237 is ideally suited for implementing non-overlapping decoders in 3-state systems and strobed (stored address) applications in bus oriented systems.

2. Features

- Combines 3-to-8 decoder with 3-bit latch
- Multiple input enable for easy expansion or independent controls
- Active HIGH mutually exclusive outputs
- Low-power dissipation
- Complies with JEDEC standard no. 7A
- ESD protection:
 - ◆ HBM EIA/JESD22-A114-B exceeds 2000 V
 - MM EIA/JESD22-A115-A exceeds 200 V.
- Multiple package options
- Specified from -40 °C to +80 °C and from -40 °C to +125 °C.



3. Quick reference data

Table 1: Quick reference data $GND = 0 \ V; T_{amb} = 25 \ ^{\circ}C; t_f = t_f = 6 \ ns.$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$t_{\text{PHL}},t_{\text{PLH}}$	propagation delay	$C_L = 15 \text{ pF}; V_{CC} = 5 \text{ V}$				
	An to Yn		-	16	-	ns
	IE to Yn		-	19	-	ns
	Ē1 to Yn		-	14	-	ns
	E2 to Yn		-	14	-	ns
Cı	input capacitance		-	3.5	-	pF
C_{PD}	power dissipation capacitance	$V_I = GND$ to V_{CC}	[1] -	60	-	pF

3-to-8 line decoder, demultiplexer with address latches

 $P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \sum (C_L \times V_{CC}{}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$

4. Ordering information

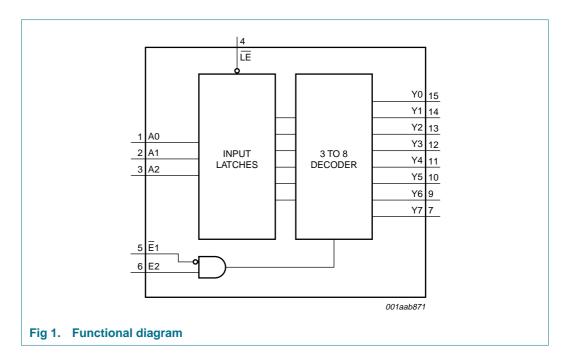
Table 2: Ordering information

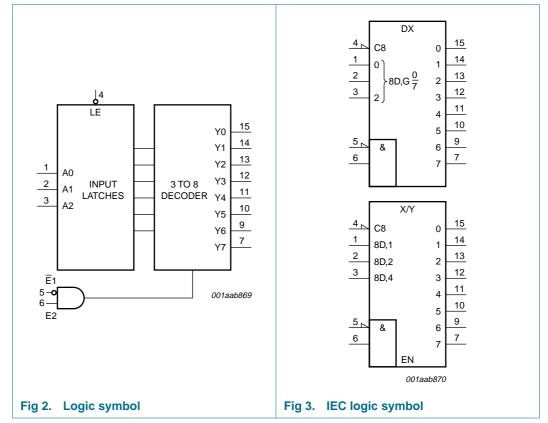
Type number	Package						
	Temperature range	Name	ame Description				
74HC237N	–40 °C to +125 °C	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4			
74HC237D	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1			
74HC237DB	–40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1			

^[1] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

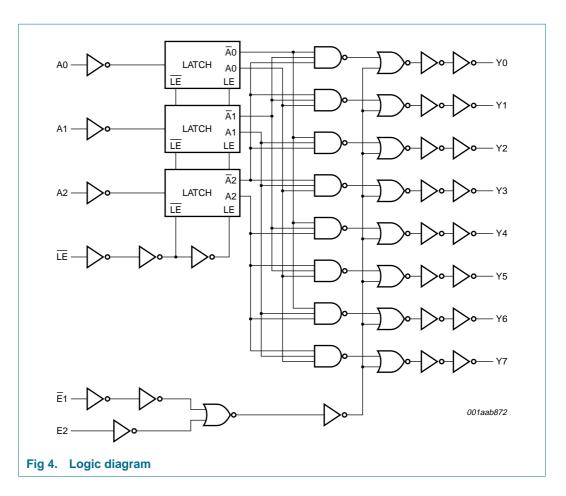
3-to-8 line decoder, demultiplexer with address latches

5. Functional diagram



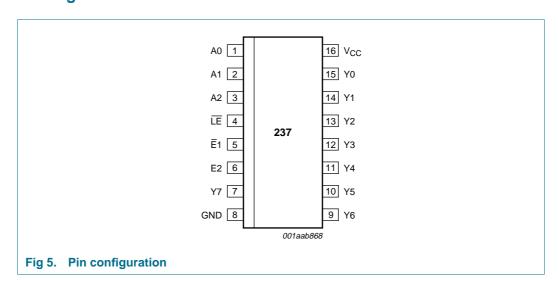


3-to-8 line decoder, demultiplexer with address latches



6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3: Pin description

Table 5.	i ili description	
Symbol	Pin	Description
A0	1	data input 0
A1	2	data input 1
A2	3	data input 2
ΙĒ	4	latch enable input (active LOW)
Ē1	5	data enable input 1 (active LOW)
E2	6	data enable input 2 (active HIGH)
Y7	7	multiplexer output 7
GND	8	ground (0 V)
Y6	9	multiplexer output 6
Y5	10	multiplexer output 5
Y4	11	multiplexer output 4
Y3	12	multiplexer output 3
Y2	13	multiplexer output 2
Y1	14	multiplexer output 1
Y0	15	multiplexer output 0
V_{CC}	16	positive supply voltage

3-to-8 line decoder, demultiplexer with address latches

7. Functional description

7.1 Function table

Table 4: Function table

Enable	е		Input			Output							
LE	E1	E2	A0	A1	A2	Y0	Y1	Y2	Y3	Y4	Y5	Y6	Y7
Н	L	Н	X	X	X	stable							
Χ	Н	Χ	X	Χ	Χ	L	L	L	L	L	L	L	L
Χ	Χ	L	X	Χ	Χ	L	L	L	L	L	L	L	L
L	L	Н	L	L	L	Н	L	L	L	L	L	L	L
			Н	L	L	L	Н	L	L	L	L	L	L
			L	Н	L	L	L	Н	L	L	L	L	L
			Н	Н	L	L	L	L	Н	L	L	L	L
			L	L	Н	L	L	L	L	Н	L	L	L
			Н	L	Н	L	L	L	L	L	Н	L	L
			L	Н	Н	L	L	L	L	L	L	Н	L
			Н	Н	Н	L	L	L	L	L	L	L	Н

^[1] H = HIGH voltage level;

L = LOW voltage level;

X = don't care.

8. Limiting values

Table 5: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

3-to-8 line decoder, demultiplexer with address latches

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CC}	supply voltage			-0.5	+7	V
I _{IK}	input diode current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$		-	±20	mA
I _{OK}	output diode current	$V_O < -0.5 \text{ V or}$ $V_O > V_{CC} + 0.5 \text{ V}$		-	±20	mA
I _O	output source or sink current	$V_0 = -0.5 \text{ V to } V_{CC} + 0.5 \text{ V}$		-	±25	mA
I _{CC} , I _{GND}	V _{CC} or GND current			-	±50	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	power dissipation					
	DIP16 package		<u>[1]</u>	-	750	mW
	SO16 and SSOP16 packages		[2]	-	500	mW

^[1] Above 70 °C: P_{tot} derates linearly with 12 mW/K.

9. Recommended operating conditions

Table 6: Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage		2.0	5.0	6.0	V
VI	input voltage		0	-	V_{CC}	V
Vo	output voltage		0	-	V_{CC}	V
t _r , t _f	input rise and fall times	$V_{CC} = 2.0 \text{ V}$	-	-	1000	ns
		V _{CC} = 4.5 V	-	6.0	500	ns
		V _{CC} = 6.0 V	-	-	400	ns
T _{amb}	ambient temperature		-40	-	+125	°C

^[2] Above 70 °C: P_{tot} derates linearly with 8 mW/K.

3-to-8 line decoder, demultiplexer with address latches



Table 7: Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = 25	°C					
V _{IH}	HIGH-level input voltage	V _{CC} = 2.0 V	1.5	1.2	-	V
		V _{CC} = 4.5 V	3.15	2.4	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 2.0 V	-	8.0	0.5	V
		V _{CC} = 4.5 V	-	2.1	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	V
VoH	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_{O} = -20 \mu A; V_{CC} = 2.0 V$	1.9	2.0	-	V
		$I_{O} = -20 \mu A; V_{CC} = 4.5 V$	4.4	4.5	-	V
		$I_{O} = -20 \mu A; V_{CC} = 6.0 V$	5.9	6.0	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	V
		$I_{O} = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	5.81	-	V
V _{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_O = 20 \mu A; V_{CC} = 2.0 V$	-	0	0.1	V
		$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	0	0.1	V
		$I_O = 20 \mu A; V_{CC} = 6.0 V$	-	0	0.1	V
		$I_{O} = 4 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.26	V
		$I_O = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	V
LI	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	μΑ
lcc	quiescent supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	8.0	μΑ
Cı	input capacitance		-	3.5	-	pF
Γ _{amb} = -40) °C to +85 °C					
√ıH	HIGH-level input voltage	V _{CC} = 2.0 V	1.5	-	-	V
		V _{CC} = 4.5 V	3.15	-	-	V
		V _{CC} = 6.0 V	4.2	-	-	V
/ _{IL}	LOW-level input voltage	V _{CC} = 2.0 V	-	-	0.5	V
		V _{CC} = 4.5 V	-	-	1.35	V
		V _{CC} = 6.0 V	-	-	1.8	V
√ _{OH}	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}				
	. •	$I_{O} = -20 \mu A$; $V_{CC} = 2.0 \text{ V}$	1.9	-	-	V
		$I_{O} = -20 \mu\text{A}; V_{CC} = 4.5 \text{V}$	4.4	-	-	V
		$I_{O} = -20 \mu\text{A}; V_{CC} = 6.0 \text{V}$	5.9	-	-	V
		$I_0 = -4 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.84	-	-	V
		$I_0 = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.34	-	-	V



 Table 7:
 Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_{O} = 20 \mu A; V_{CC} = 2.0 V$	-	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 6.0 \text{ V}$	-	-	0.1	V
		$I_{O} = 4 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.33	V
		$I_{O} = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	-	0.33	V
ILI	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±1.0	μΑ
I _{CC}	quiescent supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	80	μΑ
T _{amb} = -40	0 °C to +125 °C					
V _{IH}	HIGH-level input voltage	V _{CC} = 2.0 V	1.5	-	-	V
		V _{CC} = 4.5 V	3.15	-	-	V
		V _{CC} = 6.0 V	4.2	-	-	V
V_{IL}	LOW-level input voltage	V _{CC} = 2.0 V	-	-	0.5	V
		V _{CC} = 4.5 V	-	-	1.35	V
		V _{CC} = 6.0 V	-	-	1.8	V
V _{OH}	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_O = -20 \mu A$; $V_{CC} = 2.0 \text{ V}$	1.9	-	-	V
		$I_O = -20 \mu A$; $V_{CC} = 4.5 \text{ V}$	4.4	-	-	V
		$I_O = -20 \mu A; V_{CC} = 6.0 V$	5.9	-	-	V
		$I_O = -4 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.7	-	-	V
		$I_{O} = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.2	-	-	V
V_{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_O = 20 \mu A; V_{CC} = 2.0 V$	-	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 6.0 V$	-	-	0.1	V
		$I_{O} = 4 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.4	V
		$I_O = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	-	0.4	V
ILI	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±1.0	μΑ
I _{CC}	quiescent supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	160	μΑ



11. Dynamic characteristics

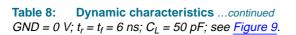
Table 8: Dynamic characteristics

 $GND = 0 \ V; \ t_r = t_f = 6 \ ns; \ C_L = 50 \ pF; \ see \ Figure \ 9.$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = 25 °C						
t _{PHL} , t _{PLH}	propagation delay An to Yn	see Figure 6				
		V _{CC} = 2.0 V	-	52	160	ns
		$V_{CC} = 4.5 \text{ V}$	-	19	32	ns
		$V_{CC} = 6.0 \text{ V}$	-	15	27	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	16	-	ns
	propagation delay LE to Yn	see Figure 6				
		V _{CC} = 2.0 V	-	61	190	ns
		V _{CC} = 4.5 V	-	22	38	ns
		V _{CC} = 6.0 V	-	18	32	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	19	-	ns
	propagation delay E1to Yn	see Figure 7				
		V _{CC} = 2.0 V	-	47	145	ns
		V _{CC} = 4.5 V	-	17	29	ns
		V _{CC} = 6.0 V	-	14	25	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	14	-	ns
	propagation delay E2 to Yn	see Figure 6				
		V _{CC} = 2.0 V	-	47	145	ns
		V _{CC} = 4.5 V	-	17	29	ns
		V _{CC} = 6.0 V	-	14	25	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	14	-	ns
THL, t _{TLH}	output transition time	see Figure 7				
		V _{CC} = 2.0 V	-	19	75	ns
		V _{CC} = 4.5 V	-	7	15	ns
		V _{CC} = 6.0 V	-	6	13	ns
W	LE pulse width HIGH	see Figure 8				
		V _{CC} = 2.0 V	50	11	-	ns
		V _{CC} = 4.5 V	10	4	-	ns
		V _{CC} = 6.0 V	9	3	-	ns
su	set-up time An to LE	see Figure 8				
		V _{CC} = 2.0 V	50	6	-	ns
		V _{CC} = 4.5 V	10	2	-	ns
		V _{CC} = 6.0 V	9	2	-	ns
h	hold time An to LE	see Figure 8				
		V _{CC} = 2.0 V	30	3	-	ns
		V _{CC} = 4.5 V	6	1	-	ns
		V _{CC} = 6.0 V	5	1	-	ns
C _{PD}	power dissipation capacitance	$V_I = GND \text{ to } V_{CC}$	<u>[1]</u> _	60	_	pF

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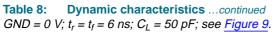
3-to-8 line decoder, demultiplexer with address latches



Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = -40 °C	to +85 °C					
t _{PHL} , t _{PLH}	propagation delay An to Yn	see Figure 6				
		V _{CC} = 2.0 V	-	-	200	ns
		V _{CC} = 4.5 V	-	-	40	ns
		V _{CC} = 6.0 V	-	-	34	ns
	propagation delay LE to Yn	see Figure 6				
		V _{CC} = 2.0 V	-	-	240	ns
		V _{CC} = 4.5 V	-	-	48	ns
		V _{CC} = 6.0 V	-	-	41	ns
	propagation delay E1 to Yn	see Figure 7				
		V _{CC} = 2.0 V	-	-	180	ns
		V _{CC} = 4.5 V	-	-	36	ns
		V _{CC} = 6.0 V	-	-	31	ns
	propagation delay E2 to Yn	see Figure 6				
		V _{CC} = 2.0 V	-	-	180	ns
		V _{CC} = 4.5 V	-	-	36	ns
		V _{CC} = 6.0 V	-	-	31	ns
t _{THL} , t _{TLH}	output transition time	see Figure 7				
		V _{CC} = 2.0 V	-	-	95	ns
		V _{CC} = 4.5 V	-	-	19	ns
		V _{CC} = 6.0 V	-	-	16	ns
t _W	LE pulse width HIGH	see Figure 8				
		V _{CC} = 2.0 V	65	-	-	ns
		V _{CC} = 4.5 V	13	-	-	ns
		$V_{CC} = 6.0 \text{ V}$	11	-	-	ns
t _{su}	set-up time An to LE	see Figure 8				
		V _{CC} = 2.0 V	65	-	-	ns
		V _{CC} = 4.5 V	13	-	-	ns
		$V_{CC} = 6.0 \text{ V}$	11	-	-	ns
t _h	hold time An to LE	see Figure 8				
		V _{CC} = 2.0 V	40	-	-	ns
		V _{CC} = 4.5 V	8	-	-	ns
		V _{CC} = 6.0 V	7	-	-	ns

Product data sheet





Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = −40 °C	to +125 °C					
t _{PHL} , t _{PLH}	propagation delay An to Yn	see Figure 6				
		V _{CC} = 2.0 V	-	-	240	ns
		V _{CC} = 4.5 V	-	-	48	ns
		$V_{CC} = 6.0 \text{ V}$	-	-	41	ns
	propagation delay LE to Yn	see Figure 6				
		V _{CC} = 2.0 V	-	-	285	ns
		V _{CC} = 4.5 V	-	-	57	ns
		V _{CC} = 6.0 V	-	-	48	ns
	propagation delay E1 to Yn	see Figure 7				
		$V_{CC} = 2.0 \text{ V}$	-	-	220	ns
		$V_{CC} = 4.5 \text{ V}$	-	-	44	ns
		$V_{CC} = 6.0 \text{ V}$	-	-	38	ns
	propagation delay E2 to Yn	see Figure 6				
		V _{CC} = 2.0 V	-	-	220	ns
		V _{CC} = 4.5 V	-	-	44	ns
		$V_{CC} = 6.0 \text{ V}$	-	-	38	ns
THL, t _{TLH}	output transition time	see Figure 7				
		V _{CC} = 2.0 V	-	-	110	ns
		V _{CC} = 4.5 V	-	-	22	ns
		V _{CC} = 6.0 V	-	-	19	ns
W	LE pulse width HIGH	see Figure 8				
		V _{CC} = 2.0 V	75	-	-	ns
		V _{CC} = 4.5 V	15	-	-	ns
		V _{CC} = 6.0 V	13	-	-	ns
su	set-up time An to LE	see Figure 8				
		V _{CC} = 2.0 V	75	-	-	ns
		V _{CC} = 4.5 V	15	-	-	ns
		V _{CC} = 6.0 V	13	-	-	ns
າ	hold time An to LE	see Figure 8				
		V _{CC} = 2.0 V	45	-	-	ns
		V _{CC} = 4.5 V	9	-	-	ns
		V _{CC} = 6.0 V	8	-	-	ns

^[1] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \sum (C_L \times V_{CC}{}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

 f_o = output frequency in MHz;

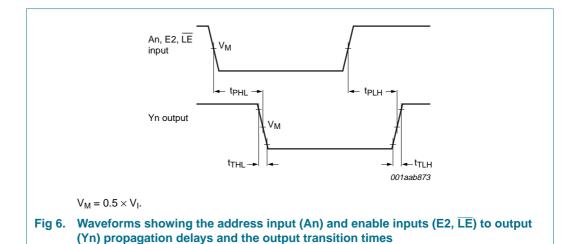
 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}{}^2 \times f_o)$ = sum of outputs.

12. Waveforms



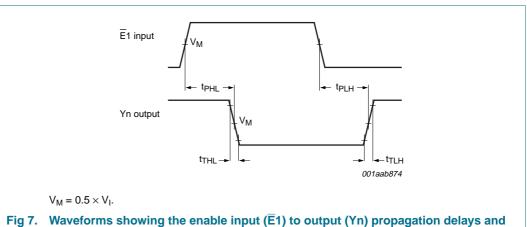


Fig 7. Waveforms showing the enable input (E1) to output (Yn) propagation delays and the output transition times

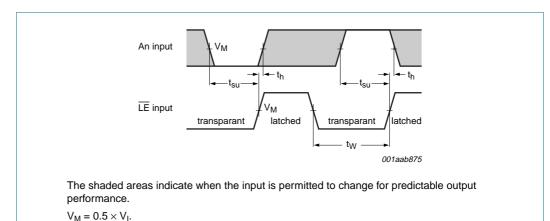


Fig 8. Waveforms showing the data set-up, hold times for An input to $\overline{\text{LE}}$ input and the latch enable pulse width

3-to-8 line decoder, demultiplexer with address latches

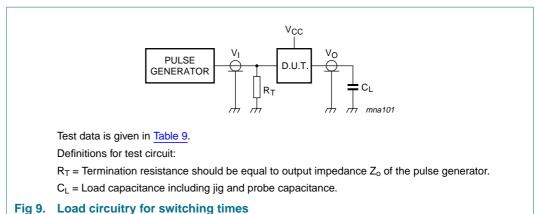
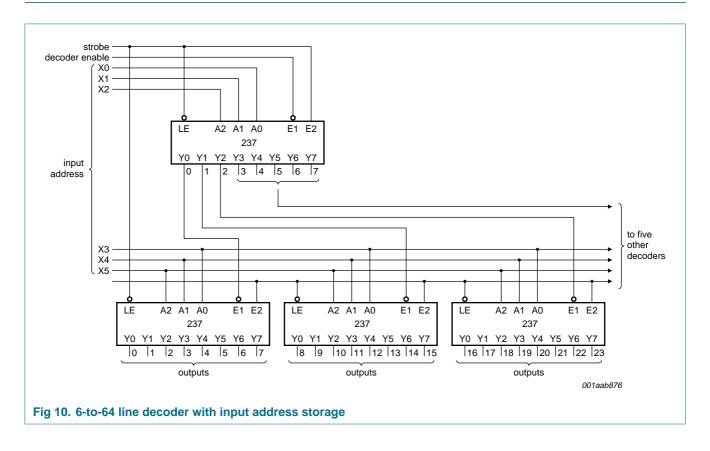


Table 9: Test data

Supply	Input	Input	
V _{CC}	V _I	t _r , t _f	CL
2.0 V	V _{CC}	6 ns	50 pF
4.5 V	V_{CC}	6 ns	50 pF
6.0 V	V_{CC}	6 ns	50 pF
5.0 V	V _{CC}	6 ns	15 pF

13. Application information



9397 750 13807

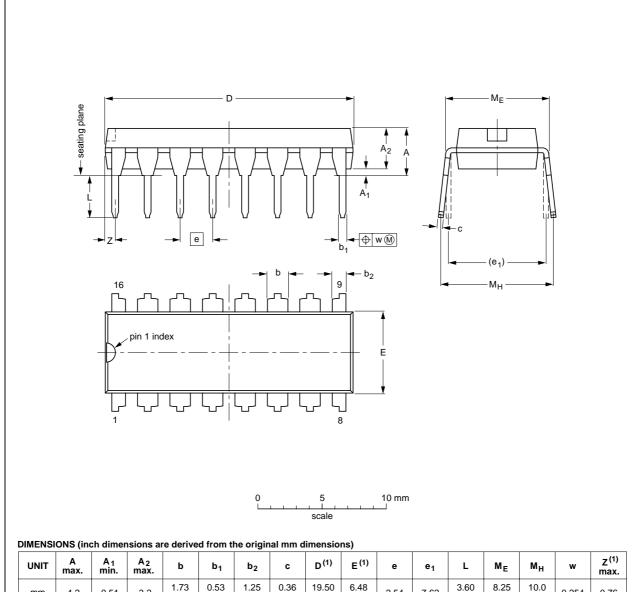
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3-to-8 line decoder, demultiplexer with address latches

14. Package outline

DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	b ₂	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.02	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.1	0.3	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.03

Note

1. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT38-4						95-01-14 03-02-13	

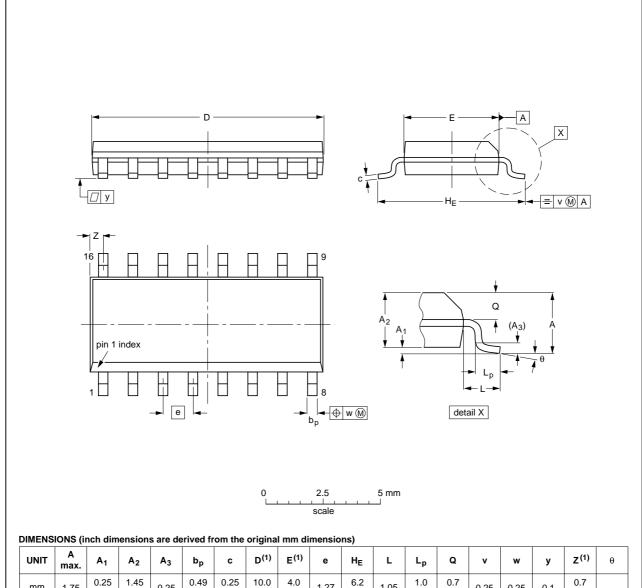
Fig 11. Package outline SOT38-4 (DIP16)

9397 750 13807

74HC237

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	ø	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016		0.01	0.01	0.004	0.028 0.012	0°

Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT109-1	076E07	MS-012				99-12-27 03-02-19	

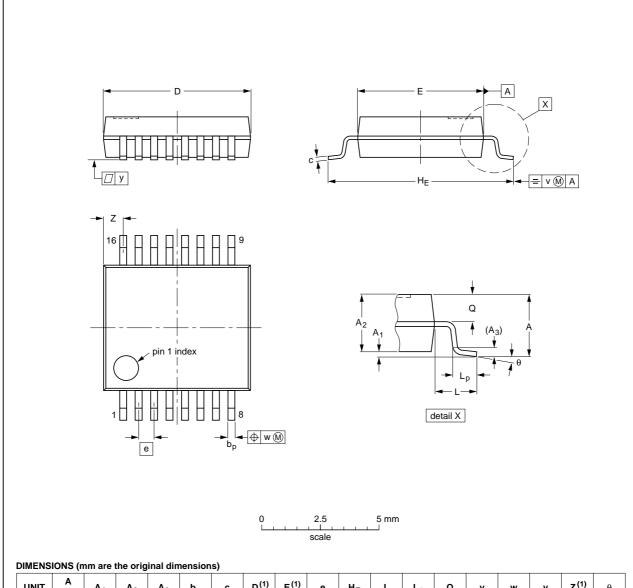
Fig 12. Package outline SOT109-1 (SO16)

9397 750 13807

74HC237

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1



-				3			-,												
	UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
	mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.00 0.55	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT338-1		MO-150				99-12-27 03-02-19

Fig 13. Package outline SOT338-1 (SSOP16)

9397 750 13807

3-to-8 line decoder, demultiplexer with address latches

15. Revision history

Table 10: Revision history

Document ID	Release date	Data sheet status	Change notice	Doc. number	Supersedes
74HC237_3	20041112	Product data sheet	-	9397 750 13807	74HC_HCT237_CNV_2
Modifications:	and infor • Removed	at of this data sheet ha mation standard of Phi d type number 74HCT2 family specification.	lips Semiconducto	• •	ne current presentation
74HC_HCT237_CNV_2	19970828	Product specification	-	-	74HC_HCT237_1
74HC_HCT237_1	19901201	Product specification	-	-	-

3-to-8 line decoder, demultiplexer with address latches



Level	Data sheet status [1]	Product status [2] [3]	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
III	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

- [1] Please consult the most recently issued data sheet before initiating or completing a design.
- [2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
- [3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

17. Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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For sales office addresses, send an email to: sales.addresses@www.semiconductors.philips.com

3-to-8 line decoder, demultiplexer with address latches

20. Contents

1	General description
2	Features
3	Quick reference data
4	Ordering information
5	Functional diagram 3
6	Pinning information4
6.1	Pinning
6.2	Pin description
7	Functional description 5
7.1	Function table
8	Limiting values 6
9	Recommended operating conditions 6
10	Static characteristics 7
11	Dynamic characteristics
12	Waveforms
13	Application information
14	Package outline
15	Revision history
16	Data sheet status
17	Definitions
18	Disclaimers
19	Contact information 18



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